

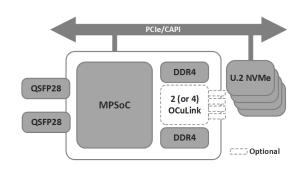
250-SoCDAA and NVMe-oF



Directly Attached Accelerator & NVMe-over-Fabric

Reliable transport of NVMe frames with low latency and high throughput

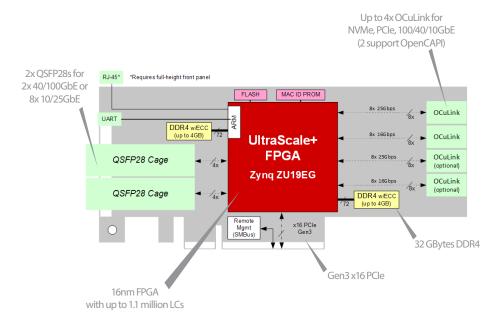
The 250-SoC enables the creation of remote, disaggregated storage or Ethernet Just-a-Bunch-of-Flash (EJBOF) to dramatically reduce the storage cost, footprint and power within data centers. The 250-SoC features a Xilinx Zynq UltraScale+ MPSoC device featuring both programmable logic and 64-bit ARM processors. This powerful, feature-rich device coordinates data transfer between two 100GbE network ports, on-board DDR4 memory and a PCle Gen 3 host interface.



key features

2x 100GbE via 2 QSFP28 Ideal for **NVMe** storage arrays

ZU19EG MPSoC: **64-bit Cortex A53 ARM** Zynq UltraScale+



Accelerating High Level Design

- Vivado HLx Editions supply design teams with the tools and methodology needed to leverage C-based design and optimized reuse
- Includes IP sub-system reuse, integration automation and accelerated design closure
- When coupled with the UltraFast™ High-Level Productivity Design Methodology Guide, this unique combination is proven to accelerate productivity
- It enables designers to work at a high level of abstraction while facilitating design

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Additional Services

Take advantage of BittWare's range of design, integration, and support options



Customization

Additional specification options or accessory boards to meet your exact needs.



Server Integration

Available pre-integrated in our <u>TeraBox servers</u> in a range of configurations.



Application Optimization

Ask about our services to help you port, optimize, and benchmark your application.



Service and Support

BittWare Developer Site provides online documentation and issue tracking.

Specifications

Specification	
FPGA	Xilinx Zynq UltraScale+ ZU19EG FFVD1760 package Core speed grade -2 Application ARM: Quad-core Cortex-A53 MP-Core 1.5GHz Real-Time ARM: Dual-core Cortex-R5 MPCore 600MHz Graphics Processor: Mali-400 MP2 Contact BittWare for other MPSoC options
On-board DDR4 SDRAM	DDR4 SDRAM FPGA Fabric Memory One 4GB bank of DDR4 SDRAM x72 bits Transfer Rate: 2400 MT/s DDR4 SDRAM MPSoC Memory One 4GB bank of DDR4 SDRAM x72 bits Transfer rate: 2400 MT/s
Host interface	 x16 mechanical PCle Gen3 capable Configurable as x16 up to Gen3, or two x8 PCl in bifurcated slots
QSFP cages	 2 front panel 4-25Gbps-lane QSFP28 cages User programmable low jitter clocking supporting 10/25/40/100GbE Each QSFP28 can be independently clocked
OCuLink	 1 back panel 8-25Gbps-lane OCuLink connector 1 back panel 8-16Gbps-lane OCuLink connector Flexible configuration: NVMe, PCle, 10/40/100GbE, OpenCAPI 2 additional optional 8-lane OCuLink connectors (25 & 16Gbps)
Board control (front panel)	RJ45 1GbE access to the ARM processor USB connector for UART to ARM processor
Datacenter Deployment, Health Monitoring & Reporting	 On-board power, voltage and temperature monitoring Field flash update via software SMBus controlled anti-bricking, fallback and multi-boot SMBus access to unique board data and temperature sensor

Cooling	Active and passive heatsink options
Electrical	 On-card power derived from PCIe slot supplies Power dissipation is application dependent Typical FPGA power consumption ~50W
Environmental	Operating temperature: 5°C to 35°C
Quality	Manufactured to ISO9001:2008 IPC JSTD-001 -Class III RoHS compliant
Form factor	Half-height, half-length PCle board Full-height PCl bracket option

Development Tools

FPGA development	BIST - Built-In Self-Test for CentOS 7 provided with source code (pinout, gateware, PCIe driver and host test application)
Application development	Xilinx Tools - Vivado Design Suite HLx Editions: HDL and C/C++ with HLS

Deliverables

- 250-SoC FPGA board
- Built-In Self-Test (BIST)
- 1-year access to online Developer Site
- 1-year hardware warranty

To learn more, visit www.BittWare.com

Rev 2020.04.28 | April 2020

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